

INFORMATION DISCLOSURE CITATION



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| Docket: 015559-250 | Serial. No.: 09/909,847 |
| Applicant: Alain Izadnegahdar et al. | |
| Filed: 7/20/2001 | Group: -2855- 3729 |

U.S. PATENT DOCUMENTS

| Examiner | Document No. | Date | Name | Class | Sub | |
|------------|--------------|---------|--------------|-------|-----|--|
| <i>NDT</i> | 6,444,487 | 9/2002 | Boggs et al. | — | — | |
| <i>NDT</i> | 6,001,666 | 12/1999 | Diem et al. | — | — | |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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|------------------------------|--|
| <i>NDT</i> | Kaneko, S. et al., "Monolithic Fabrication of Flexible Film and Thinned Integrated Circuits," Proceedings IEEE 10 th Annual Workshop on MEMS, 1997 |
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| Examiner: <i>[Signature]</i> | Date Considered: <i>2/20/04</i> |

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U.S. PATENT DOCUMENTS

| Examiner | Document No. | Date | Name | Class | Sub | |
|------------|--------------|---------|-----------------|----------------|----------|--|
| <i>NOT</i> | 6,316,796 | 11/2001 | Petersen et al. | 1 | 1 | |
| <i>NOT</i> | 6,084,257 | 07/2000 | Petersen et al. | 1 | 1 | |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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|------------------------------|---|
| <i>NOT</i> | Petersen, K. et al., "Surface Micromachined Structures Fabricated with Silicon Fusion Bonding," 1991 IEEE, pp. 397-399 (5/1991) |
| <i>NOT</i> | Petersen, K. et al., "Silicon Fusion Bonding for Pressure Sensors," 1988 IEEE, pp. 144-147 (4/1988) |
| | |
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